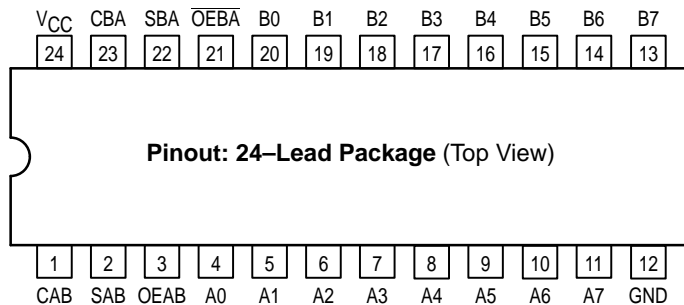


Low-Voltage Quiet CMOS Octal Transceiver/Registered Transceiver With Dual Enable (3-State, Non-Inverting)

The MC74LVQ652 is a high performance, non-inverting octal transceiver/registered transceiver operating from a 2.7 to 3.6V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. The MC74LVQ652 is suitable for memory address driving and all TTL level bus oriented transceiver applications.

Data on the A or B bus will be clocked into the registers as the appropriate clock pin goes from a LOW-to-HIGH logic level. Two Output Enable pins (\overline{OEBA} , OEAB) are provided to control the transceiver outputs. In the transceiver mode, data present at the high impedance port may be stored in either the A or the B register or in both. The select controls (SBA, SAB) can multiplex stored and real-time (transparent mode) data. In the isolation mode (both outputs disabled), A data may be stored in the B register or B data may be stored in the A register. When in the real-time mode, it is possible to store data without using the internal registers by simultaneously enabling OEAB and \overline{OEBA} . In this configuration, each output reinforces its input.

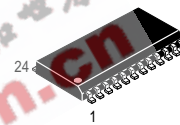
- Designed for 2.7 to 3.6V V_{CC} Operation – Ideal for Low Power/Low Noise Applications
- Guaranteed Simultaneous Switching Noise Level and Dynamic Threshold Performance
- Guaranteed Skew Specifications
- Guaranteed Incident Wave Switching into 75 Ω
- Low Static Supply Current (10 μ A) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 500mA
- ESD Performance: Human Body Model >2000V



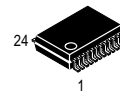
MC74LVQ652

LVQ

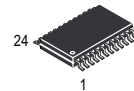
**LOW-VOLTAGE CMOS
OCTAL TRANSCEIVER/
REGISTERED TRANSCEIVER
WITH DUAL ENABLE**



DW SUFFIX
PLASTIC SOIC
CASE 751E-04



SD SUFFIX
PLASTIC SSOP
CASE 940D-03



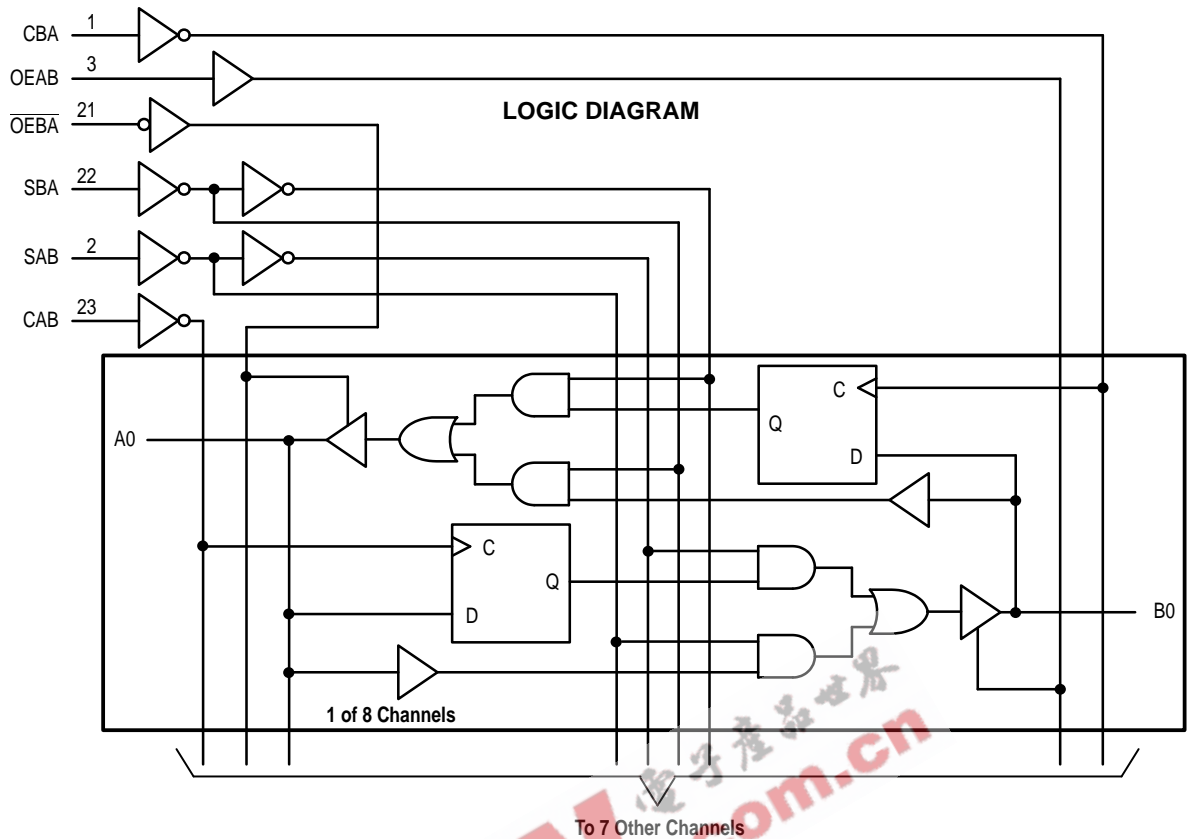
DT SUFFIX
PLASTIC TSSOP
CASE 948H-01

PIN NAMES

Pins	Function
A0–A7	Side A Inputs/Outputs
B0–B7	Side B Inputs/Outputs
CAB, CBA	Clock Pulse Inputs
SAB, SBA	Select Control Inputs
OEBA, OEAB	Output Enable Inputs



MC74LVQ652



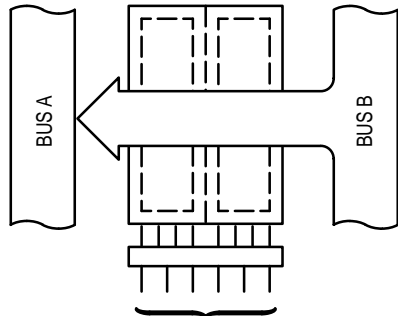
FUNCTION TABLE

Inputs						Storage Registers		Data Ports		Operating Mode
OEAB	OEBA	CAB	CBA	SAB	SBA	Q _A	Q _B	A _n	B _n	
L	H							Input	Input	
		↑	↑	X	X	NC	NC	X	X	Isolation, Hold Storage
		↑	↑	X	X	L	X	L	X	Store A and/or B Data
						H	X	X	X	
						X	L	X	L	
						X	H	X	H	
H	H							Input	Output	
		↑	X*	L	X	NC	NC	L	L	Real Time A Data to B Bus
				H	X	NC	NC	X	Q _A	Stored A Data to B Bus
		↑	X*	L	X	L	NC	L	L	Real Time A Data to B Bus; Store A Data
						H	X	L	H	
						L	NC	L	Q _A	Stored A Data to B Bus; Store A Data
						H	NC	L	Q _A	
L	L							Output	Input	
		X*	↑	X	L	NC	NC	L	L	Real Time B Data to A Bus
				X	H	NC	NC	Q _B	X	Stored B Data to A Bus
		X*	↑	X	L	NC	L	L	L	Real Time B Data to A Bus; Store B Data
						H	X	L	H	
						X	NC	L	Q _B	Stored B Data to A Bus; Store B Data
						H	NC	L	Q _B	
						X	H	L	H	
H	L							Output	Output	
		↑	↑	H	H	NC	NC	Q _B	Q _A	Stored A Data to B Bus, Stored B Data to A Bus

H = High Voltage Level; L = Low Voltage Level; X = Don't Care; ↑ = Low-to-High Clock Transition; ↑ = NOT Low-to-High Clock Transition; NC = No Change; * = The clocks are not internally gated with either the Output Enables or the Source Inputs. Therefore, data at the A or B ports may be clocked into the storage registers, at any time. For I_{CC} reasons, Do Not Float Inputs.

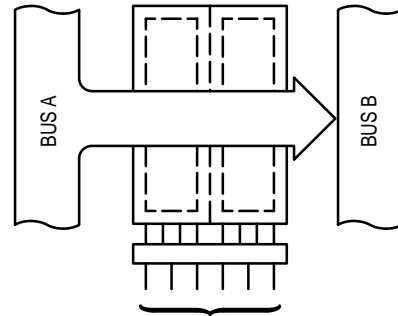
BUS APPLICATIONS

Real Time Transfer – Bus B to Bus A



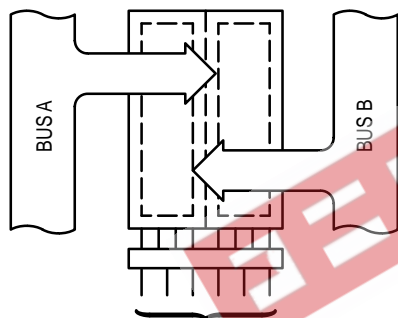
OEAB	\overline{OEBA}	CAB	CBA	SAB	SBA
L	L	X	X	X	L

Real Time Transfer – Bus A to Bus B



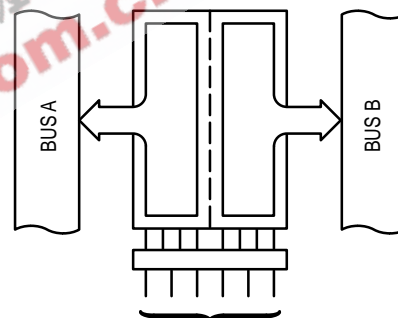
OEAB	\overline{OEBA}	CAB	CBA	SAB	SBA
H	H	X	X	L	X

Store Data from Bus A, Bus B or Bus A and Bus B



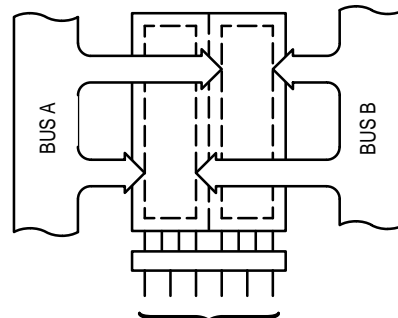
OEAB	\overline{OEBA}	CAB	CBA	SAB	SBA
X	H	↑	X	X	X
L	X	X	↑	X	X
L	H	↑	↑	X	X

Transfer A Stored Data to Bus B or Stored Data Bus B to Bus A or Both at the Same Time



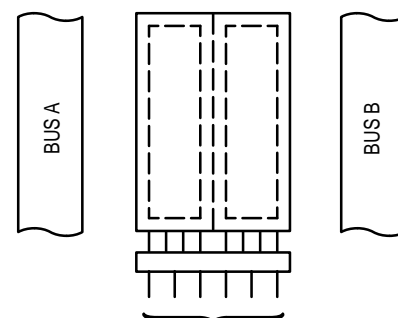
OEAB	\overline{OEBA}	CAB	CBA	SAB	SBA
H	H	H or L	X	H	X
L	L	X	H or L	X	H
H	L	H or L	H or L	H	H

Store Bus A in Both Registers or Store Bus B in Both Registers



OEAB	\overline{OEBA}	CAB	CBA	SAB	SBA
H	H	↑	↑	L	X
L	L	↑	↑	X	L

Isolation



OEAB	\overline{OEBA}	CAB	CBA	SAB	SBA
L	H	H or L	H or L	X	X

MC74LVQ652

ABSOLUTE MAXIMUM RATINGS*

Symbol	Parameter	Value	Condition	Unit
V _{CC}	DC Supply Voltage	-0.5 to +7.0		V
V _I	DC Input Voltage	-0.5 ≤ V _I ≤ V _{CC} + 0.5V		V
V _O	DC Output Voltage	-0.5 ≤ V _O ≤ V _{CC} + 0.5	Output in HIGH or LOW State	V
I _{IK}	DC Input Diode Current	-20	V _I = -0.5V	mA
		+20	V _I = V _{CC} + 0.5V	mA
I _{OK}	DC Output Diode Current	-20	V _O = -0.5V	mA
		+20	V _I = V _{CC} + 0.5V	mA
I _O	DC Output Source/Sink Current	±50		mA
I _{CC}	DC Supply Current	±400		mA
I _{GND}	DC Ground Current	±400		mA
T _{STG}	Storage Temperature Range	-65 to +150		°C

* Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Typ	Max	Unit
V _{CC}	Supply Voltage	2.0	3.3	3.6	V
V _I	Input Voltage	0		V _{CC}	V
V _O	Output Voltage	0		V _{CC}	V
T _A	Operating Free-Air Temperature	-40		+85	°C
ΔV/Δt	Input Transition Rise or Fall Rate, V _{IN} from 0.8V to 2.0V, V _{CC} = 3.0V	0		125	mV/ns

DC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic	Condition	T _A = -40°C to +85°C		Unit
			Min	Max	
V _{IH}	HIGH Level Input Voltage (Note 1)	2.7V ≤ V _{CC} ≤ 3.6V, V _O = 0.1V or V _{CC} - 0.1V	2.0		V
V _{IL}	LOW Level Input Voltage (Note 1)	2.7V ≤ V _{CC} ≤ 3.6V, V _O = 0.1V or V _{CC} - 0.1V		0.8	V
V _{OH}	HIGH Level Output Voltage	2.7V ≤ V _{CC} ≤ 3.6V; I _{OH} = -50μA	V _{CC} - 0.1		V
		V _{CC} = 2.7V; I _{OH} = -12mA	2.2		
		V _{CC} = 3.0V; I _{OH} = -12mA	2.48		
V _{OL}	LOW Level Output Voltage	2.7V ≤ V _{CC} ≤ 3.6V; I _{OL} = 50μA		0.1	V
		2.7V ≤ V _{CC} ≤ 3.6V; I _{OL} = 12mA		0.4	
I _I	Input Leakage Current	2.7V ≤ V _{CC} ≤ 3.6V; V _I = V _{CC} , GND		±1.0	μA
I _{OZT}	Maximum I/O Leakage Current	V _I (\overline{OE}) = V _{IL} , V _{IH} ; V _I , V _O = V _{CC} , GND		±3	μA
I _{OLD}	Minimum Dynamic Output Current (Note 2)	V _{CC} = 3.6V; V _{OLD} = 0.8V Max		36	mA
		V _{CC} = 3.6V; V _{OHD} = 2.0V Min		-25	
I _{CC}	Quiescent Supply Current	2.7V ≤ V _{CC} ≤ 3.6V; V _I = V _{CC} , GND		10	μA

1. These values of V_I are used to test DC electrical characteristics only. Functional test should use V_{IH} ≥ 2.4V, V_{IL} ≤ 0.5V.
2. Incident wave switching on transmission lines with impedances as low as 75Ω for commercial temperature range is guaranteed. Maximum test duration is 2ms, one output loaded at a time.

DYNAMIC SWITCHING CHARACTERISTICS ($V_{CC} = 3.3V$)

Symbol	Characteristic	Condition	$T_A = +25^\circ C$			Unit
			Min	Typ	Max	
V_{OLP}	Dynamic LOW Peak Voltage (Note 1)	$C_L = 50pF, V_{IH} = 3.3V, V_{IL} = 0V$		0.6	1.0	V
V_{OLV}	Dynamic LOW Valley Voltage (Note 1)	$C_L = 50pF, V_{IH} = 3.3V, V_{IL} = 0V$		-0.5	-1.0	V
V_{IHD}	High Level Dynamic Input Voltage (Note 2)	Input-Under-Test Switching 0V to Threshold, $f=1MHz$		1.5	2.0	V
V_{ILD}	Low Level Dynamic Input Voltage (Note 2)	Input-Under-Test Switching 3.3V to Threshold, $f=1MHz$		1.5	0.8	V

- Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW. The remaining output is measured in the LOW state.
- Number of data inputs is defined as "n" switching, "n-1" inputs switching 0V to 3.3V.

AC CHARACTERISTICS¹ ($t_R = t_F = 2.5ns; C_L = 50pF; R_L = 500\Omega$)

Symbol	Parameter	Limits									Unit
		$T_A = +25^\circ C$						$T_A = -40^\circ C$ to $+85^\circ C$			
		$V_{CC} = 3.0V$ to $3.6V$			$V_{CC} = 2.7V$			$V_{CC} = 3.0V$ to $3.6V$		$V_{CC} = 2.7V$	
		Min	Typ	Max	Min	Typ	Max	Min	Max	Max	
f_{max}	Clock Pulse Frequency	150						150			MHz
t_{PLH} t_{PHL}	Propagation Delay Clock to Output	2.5	13.0	16.0	2.5	15.0	18.0	2.5	18.0	19.0	ns
t_{PLH} t_{PHL}	Propagation Delay Input to Output	2.5	9.0	12.0	2.5	11.0	14.0	2.5	13.5	16.0	ns
t_{PLH} t_{PHL}	Propagation Delay Select to Output	2.5	10.0	13.0	2.5	12.0	15.0	2.5	14.0	16.0	ns
t_{PZH} t_{PZL}	Output Enable Time to High and Low Level	1.5	10.5	13.5	1.5	13.0	15.0	1.5	14.0	16.5	ns
t_{PHZ} t_{PLZ}	Output Disable Time From High and Low Level	1.5	11.0	13.5	1.5	12.0	15.0	1.5	14.5	16.0	ns
t_{OSHL} t_{OSLH}	Output-to-Output Skew (Note 2)			1.0					1.0		ns

- These AC parameters are preliminary and may be modified prior to release. The maximum AC limits are design targets. Actual performance will be specified upon completion of characterization.
- Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}); parameter guaranteed by design.

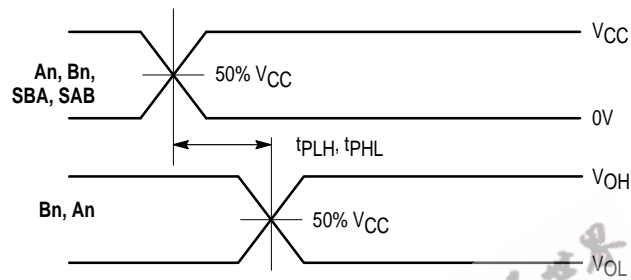
AC OPERATING REQUIREMENTS ($t_R = t_F = 2.5ns; C_L = 50pF; R_L = 500\Omega$)

Symbol	Parameter	Limits				Unit
		$T_A = +25^\circ C$		$T_A = -40^\circ C$ to $+85^\circ C$		
		$V_{CC} = 3.0V$ to $3.6V$		$V_{CC} = 2.7V$		
		Min	Min	Min	Min	
t_s	Setup Time, HIGH or LOW Dn to LE	2.5	4.0	2.5	4.5	ns
t_h	Hold Time, HIGH or LOW Dn to LE	1.5	1.5	1.5	1.5	ns
t_w	LE Pulse Width, HIGH	3.3	4.5	3.3	4.5	ns

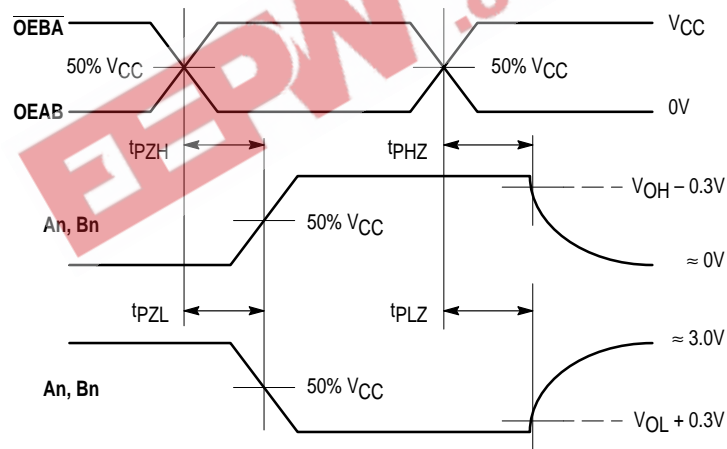
MC74LVQ652

CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Condition	Typical	Unit
C _{PD}	Power Dissipation Capacitance	10MHz, V _{CC} = 3.3V, V _I = 0V or V _{CC}	50	pF
C _{IN}	Input Capacitance	V _{CC} = Open, V _I = 0V or V _{CC}	4.5	pF
C _{I/O}	Input/Output Capacitance	V _{CC} = 3.3V, V _I = 0V or V _{CC}	15	pF

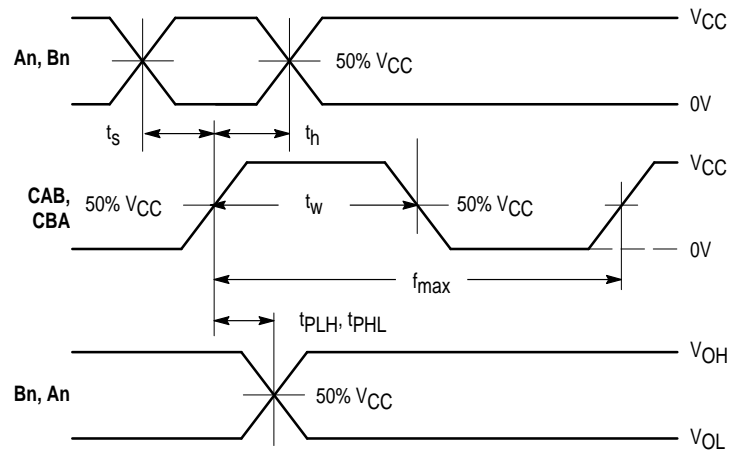


WAVEFORM 1 – SAB to B and SBA to A, An to Bn PROPAGATION DELAYS
 $t_R = t_F = 2.5\text{ns}$, 10% to 90%; $f = 1\text{MHz}$; $t_W = 500\text{ns}$



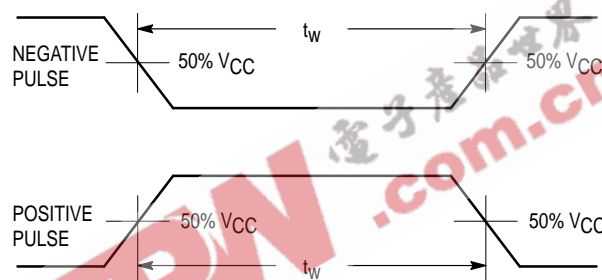
WAVEFORM 2 – $\overline{\text{OE}}/\text{DIR}$ to An/Bn OUTPUT ENABLE AND DISABLE TIMES
 $t_R = t_F = 2.5\text{ns}$, 10% to 90%; $f = 1\text{MHz}$; $t_W = 500\text{ns}$

Figure 1. AC Waveforms



WAVEFORM 3 – CLOCK to Bn/An PROPAGATION DELAYS, CLOCK MINIMUM PULSE WIDTH, An/Bn to CLOCK SETUP AND HOLD TIMES

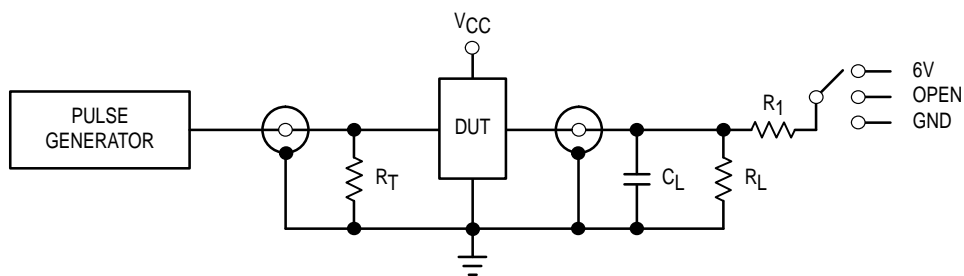
$t_R = t_F = 2.5\text{ns}$, 10% to 90%; $f = 1\text{MHz}$; $t_W = 500\text{ns}$ except when noted



WAVEFORM 4 – INPUT PULSE DEFINITION

$t_R = t_F = 2.5\text{ns}$, 10% to 90% of 0V to V_{CC}

Figure 2. AC Waveforms



TEST	SWITCH
t_{PLH} , t_{PHL}	Open
t_{PZL} , t_{PLZ}	6V
Open Collector/Drain t_{PLH} and t_{PHL}	6V
t_{PZH} , t_{PHZ}	GND

$C_L = 50\text{pF}$ or equivalent (Includes jig and probe capacitance)

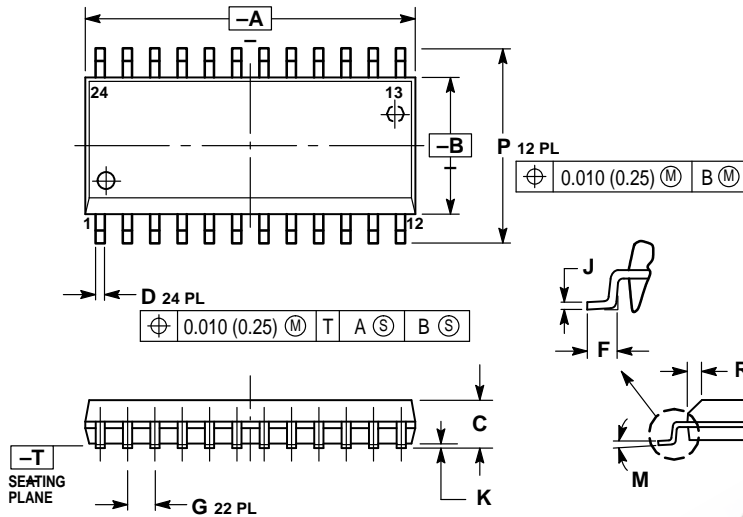
$R_L = R_1 = 500\Omega$ or equivalent

$R_T = Z_{OUT}$ of pulse generator (typically 50Ω)

Figure 3. Test Circuit

OUTLINE DIMENSIONS

DW SUFFIX
 PLASTIC SOIC PACKAGE
 CASE 751E-04
 ISSUE E

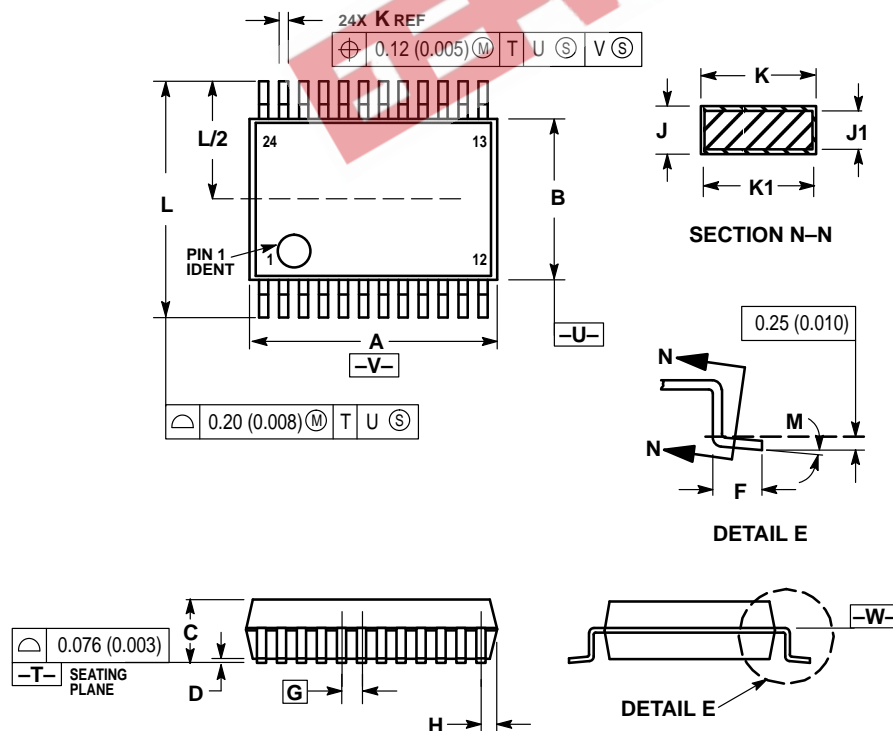


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	15.25	15.54	0.601	0.612
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.41	0.90	0.016	0.035
G	1.27 BSC		0.050 BSC	
J	0.23	0.32	0.009	0.013
K	0.13	0.29	0.005	0.011
M	0° - 8°		0° - 8°	
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

SD SUFFIX
 PLASTIC SSOP PACKAGE
 CASE 940D-03
 ISSUE B



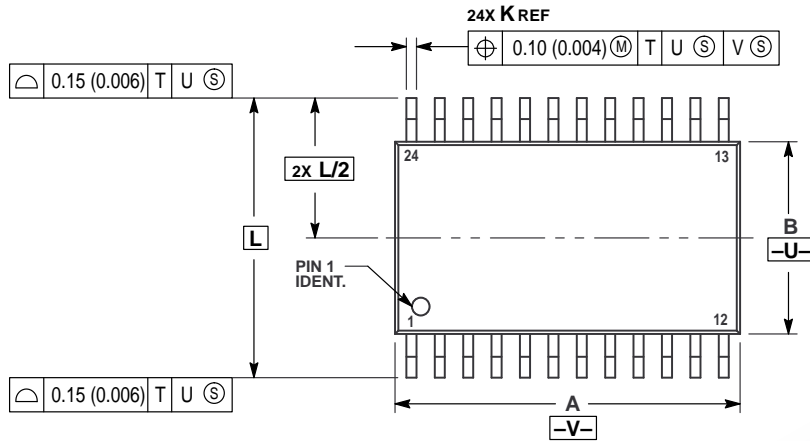
NOTES:

- 4 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 5 CONTROLLING DIMENSION: MILLIMETER.
- 6 DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- 7 DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- 8 DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION/INTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF K DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR INTRUSION SHALL NOT REDUCE DIMENSION K BY MORE THAN 0.07 (0.002) AT LEAST MATERIAL CONDITION.
- 9 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- 10 DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

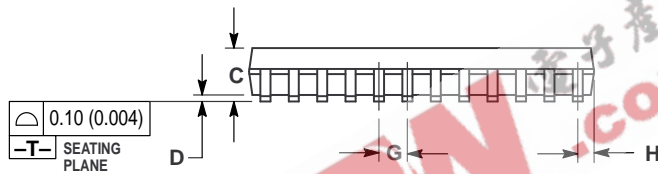
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.07	8.33	0.317	0.328
B	5.20	5.38	0.205	0.212
C	1.73	1.99	0.068	0.078
D	0.05	0.21	0.002	0.008
F	0.63	0.95	0.024	0.037
G	0.65 BSC		0.026 BSC	
H	0.44	0.60	0.017	0.024
J	0.09	0.20	0.003	0.008
J1	0.09	0.16	0.003	0.006
K	0.25	0.38	0.010	0.015
K1	0.25	0.33	0.010	0.013
L	7.65	7.90	0.301	0.311
M	0° - 8°		0° - 8°	

OUTLINE DIMENSIONS

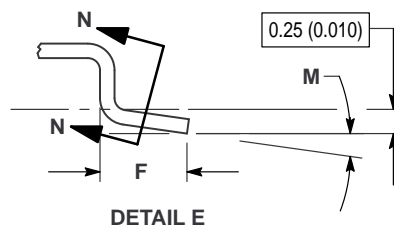
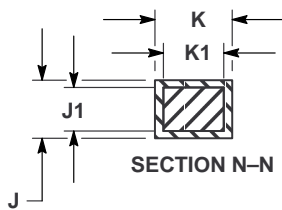
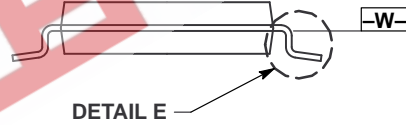
DT SUFFIX
 PLASTIC TSSOP PACKAGE
 CASE 948H-01
 ISSUE O



- NOTES:
- 1 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 - 2 CONTROLLING DIMENSION: MILLIMETER.
 - 3 DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 - 4 DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
 - 5 DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
 - 6 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 - 7 DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.




DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	7.70	7.90	0.303	0.311
B	4.30	4.50	0.169	0.177
C	—	1.20	—	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.27	0.37	0.011	0.015
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°



MC74LVQ652

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How to reach us:

USA/EUROPE: Motorola Literature Distribution;
P.O. Box 20912; Phoenix, Arizona 85036. 1-800-441-2447

JAPAN: Nippon Motorola Ltd.; Tatsumi-SPD-JLDC, Toshikatsu Otsuki,
6F Seibu-Butsuryu-Center, 3-14-2 Tatsumi Koto-Ku, Tokyo 135, Japan. 03-3521-8315

MFAX: RMFAX0@email.sps.mot.com -TOUCHTONE (602) 244-6609
INTERNET: <http://Design-NET.com>

HONG KONG: Motorola Semiconductors H.K. Ltd.; 8B Tai Ping Industrial Park,
51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852-26629298



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